

ZXCT1081 High voltage high-side current monitor

Description

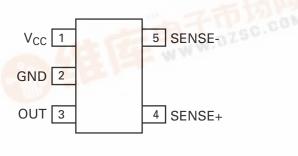
The ZXCT1081 is a high side current sense monitor with a gain of 10 and a voltage output. Using this device eliminates the need to disrupt the ground plane when sensing a load current.

The wide input voltage range of 40V down to as low as 3V make it suitable for a range of applications; including systems operating from industrial 24-28V rails and power supplies.

Features

- 3V to 40V continuous high side voltage
- Accurate high-side current sensing
- Output voltage scaling x10
- 4.5V to 12V V_{CC} range
- Low quiescent current:
 - 80µA supply pin
 - 30µA I_{SENSE+}
- SOT23-5 package
- -40°C to 125°C ambient temperature range

Pin connections



Ordering information

sues - January 2007

.com

Zetex Semiconductors plc 2007

Device	Package	Part mark	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXCT1081E5TA	SOT23-5	1081	7	8	3000

-1

Applications

output.

Automotive current measurement

temperature range of -40°C to 125°C.

Industrial applications current measurement

The separate supply pin (V_{CC}) allows the device

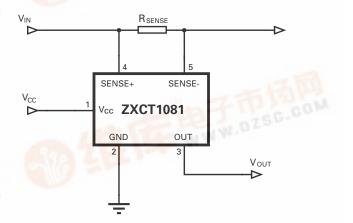
to continue functioning under short circuit

conditions, giving an end stop voltage at the

For automotive applications the ZXCT1081 has a 60V transient capability and ambient

- Battery management
- Over current monitor
- Power management
- Power adapters

Typical application circuit



Absolute maximum ratings

Continuous voltage on SENSE+ and SENSE-	-0.6V and 45V
Transient voltage on SENSE+ and SENSE-	-0.6V and 65V
Voltage on all other pins	-0.6V and 14V
Differential sense voltage, V _{SENSE}	800mV
Operating temperature	-40°C to 125°C
Storage temperature	-55°C to 150°C
Maximum junction temperature	85°C
Package power dissipation	300mW at $T_A = 25^{\circ}C$ (de-rate to zero at 125°C)

Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability.

Recommended operating conditions

Parameter		Min.	Max.	Units
V _{IN}	Common-mode sense+ input range	3	40	V
V _{CC}	Supply voltage range	4.5	12	V
V _{SENSE}	Differential sense input voltage range	0	0.15	V
V _{OUT}	Output voltage range	0	1.5	V
TJ	Ambient temperature range	-40	125	°C

Pin function table

Pin	Name	Description
1	V _{CC}	This is the analogue supply and provides power to internal circuitry
2	GND	Ground pin
3	OUT	Output voltage pin. NMOS source follower with 20µA bias to ground
4	SENSE+	This is the positive input of the current monitor and has an input range from 60V down to 3V. The current through this pin varies with differential sense voltage
5	SENSE-	This is the negative input of the current monitor and has an input range from 60V down to 3V

Electrical characteristics

Test conditions $T_A = 25^{\circ}C$, $V_{IN} = 12V$, $V_{CC} = 5 V$, $V_{SENSE}^{(a)} = 100 \text{mV}$ unless otherwise stated.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
I _{CC}	V _{CC} supply current	V _{CC} = 12V	40	80	120	μA
I _{SENSE+}	SENSE+ input current		15	30	60	μA
I _{SENSE-}	SENSE- input current		10	40	80	nA
V _{O(0)}	Zero V _{SENSE} ^(a) error ^(b)	V _{SENSE} ^(a) = 0V	0		35	mV
V _{O(10)}	Output offset voltage ^(c)	V _{SENSE} ^(a) = 10mV	-30		+30	mV
Gain	$\Delta V_{OUT} / \Delta V_{SENSE}^{(a)}$	V _{SENSE} ^(a) = 10mV to 150mV	9.95	10	10.05	
V _{OUT} TC ^(d)	V _{OUT} variation with temperature			30		ppm/°C
Acc	Total output error		-3		3	%
I _{ОН}	Output source current	$\Delta V_{OUT} = -30 mV$		1		mA
I _{OL}	Output sink current	$\Delta V_{OUT} = +30 mV$		20		μA
PSRR	V _{CC} supply rejection ratio	V _{CC} = 4.5V to 12V	54	60		dB
CMRR	Common-mode sense rejection ratio	V _{IN} = 40V to 3V	60	75		dB
BW	-3dB small signal bandwidth	$V_{SENSE}^{(a)}_{(AC)} = 10mV_{PP}$		500		kHz

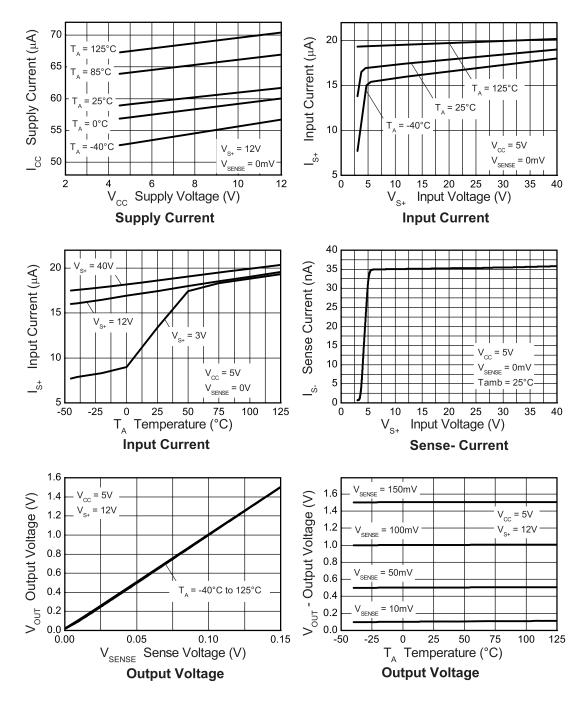
NOTES:

(a) $V_{SENSE} = "V_{SENSE+}" - "V_{SENSE-}"$ (b) The ZXCT1081 operates from a positive power rail and the internal voltage-current converter current flow is unidirectional; these result in the output offset voltage for $V_{SENSE} = 0V$ always being positive.

(c) For V_{SENSE} > 10mV, the internal voltage-current converter is fully linear. This enables a true offset to be defined and used. V_{O(10)} is expressed as the variance about an output voltage of 100mV>
(d) Temperature dependent measurements are extracted from characterization and simulation results.

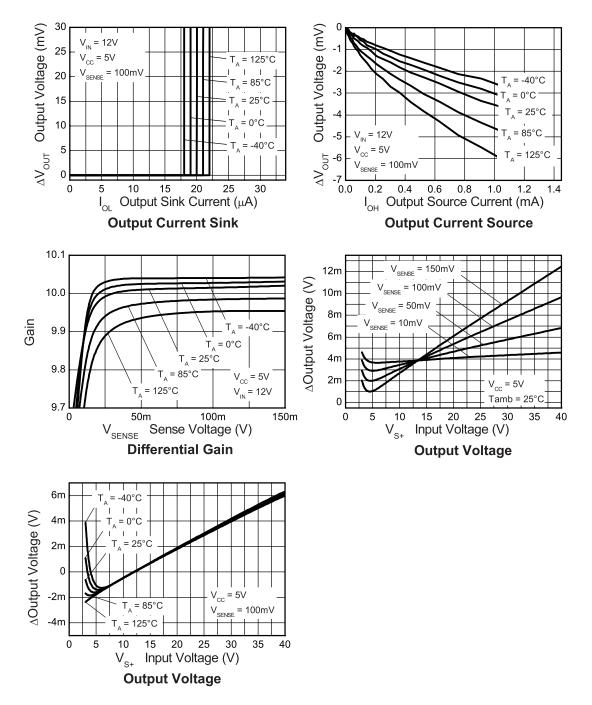
Typical characteristics

Test conditions unless otherwise stated: $T_A = 25^{\circ}C$, $V_{CC} = 5V$, $V_{SENSE+} = 12V$, $V_{SENSE} = 100mV$



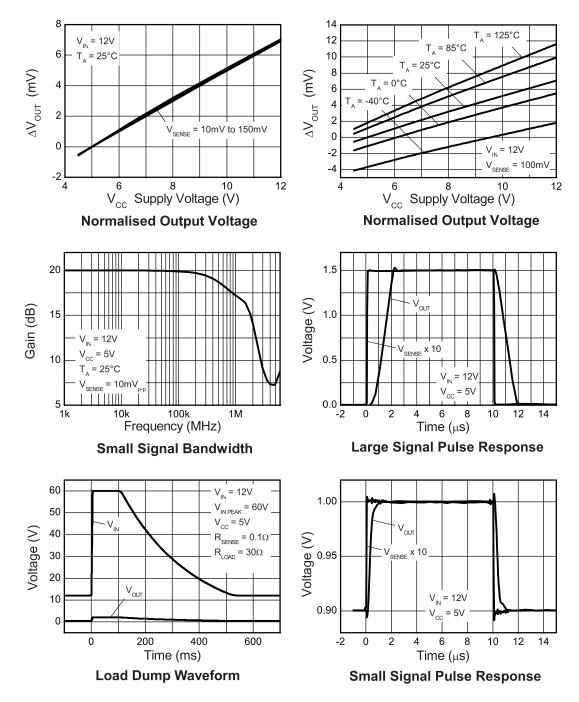
Typical characteristics

Test conditions unless otherwise stated: $T_A = 25^{\circ}C$, $V_{CC} = 5V$, $V_{SENSE+} = 12V$, $V_{SENSE} = 100mV$

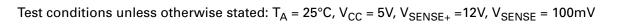


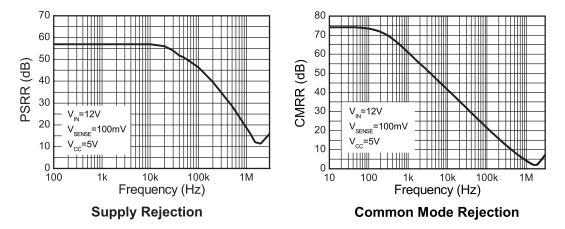
Typical characteristics

Test conditions unless otherwise stated: $T_A = 25^{\circ}C$, $V_{CC} = 5V$, $V_{SENSE+} = 12V$, $V_{SENSE} = 100mV$



Typical characteristics





Application information

The ZXCT1081 has been designed to allow it to operate with 5V supply rails while sensing common mode signals up to 40V. This makes it well suited to a wide range of industrial and power supply monitoring applications that require the interface to 5V systems while sensing much higher voltages.

To allow this its V_{CC} pin can be used independently of SENSE+.

Figure 1 shows the basic configuration of the ZXCT1081.

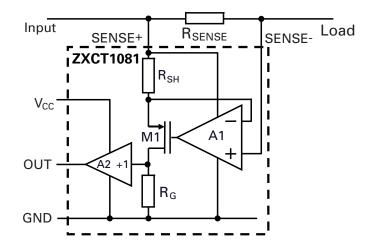


Figure 1 Typical configuration of ZXCT1081

Load current from the input is drawn through $\rm R_{SENSE}$ developing a voltage $\rm V_{SENSE}$ across the inputs of the ZXCT1081.

The internal amplifier forces V_{SENSE} across internal resistance R_{SH} causing a current to flow through MOSFET M1. This current is then converted to a voltage by R_G . A ratio of 10:1 between R_G and R_{SH} creates the fixed gain of 10. The output is then buffered by the unity gain buffer.

The gain equation of the ZXCT1081 is:

$$V_{OUT} = I_L R_{SENSE} \frac{R_G}{R_{SH}} \times 1 = I_L \times R_{SENSE} \times 10$$

The maximum recommended differential input voltage, V_{SENSE}, is 150mV; it will however withstand voltages up to 800m Ω . This can be increased further by the inclusion of a resistor, R_{LIM}, between SENSE- pin and the load; typical value is of the order of 10k.

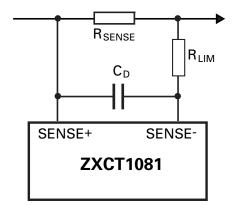


Figure 2 Protection/error sources for ZXCT1081

Capacitor C_{D} provides high frequency transient decoupling when used with R_{LIM} ; typical values are of the order 10pF

For best performance R_{SENSE} should be connected as close to the SENSE+ (and SENSE) pins; minimizing any series resistance with $R_{SENSE}.$

When choosing appropriate values for R_{SENSE} a compromise must be reached between in-line signal loss (including potential power dissipation effects) and small signal accuracy.

Higher values for R_{SENSE} gives better accuracy at low load currents by reducing the inaccuracies due to internal offsets. For best operation the ZXCT1081 has been designed to operate with V_{SENSE} of the order of 50mV to 150mV.

Current monitors' basic configuration is that of a unipolar voltage to current to voltage converter powered from a single supply rail. The internal amplifier at the heart of the current monitor may well have a bipolar offset voltage but the output cannot go negative; this results in current monitors saturating at very low sense voltages.

As a result of this phenomenon the ZXCT1081 has been specified to operate in a linear manner over a V_{SENSE} range of 10mV to 150mV range, however it will still be monotonic down to $_{VSENSE}$ of 0V.

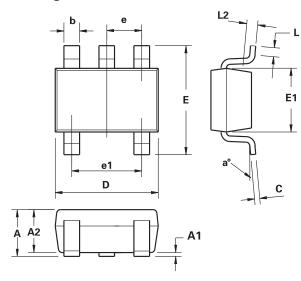
It is for this very reason that Zetex has specified an input offset voltage ($V_{O(10)}$) at 10mV. The output voltage for any V_{SENSE} voltage from 10mV to 150mV can be calculated as follows:

 $V_{OUT} = (V_{SENSE})xG + V_{O(10)}$

Alternatively the load current can be expressed as:

$$I_{L} = \frac{(V_{OUT} - V_{O(10)})}{GxR_{SENSE}}$$

Package details - SOT23-5



DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	-	1.00	-	0.0393
A1	0.01	0.10	0.0003	0.0039
A2	0.84	0.90	0.0330	0.0354
b	0.30	0.45	0.0118	0.0177
С	0.12	0.20	0.0047	0.0078
D	2.9	0 BSC	0.114	4 BSC
E	2.8	0 BSC	0.110) BSC
E1	1.6	0 BSC	0.062	2 BSC
е	0.9	5 BSC	0.037	4 BSC
e1	1.9	0 BSC	0.074	8 BSC
L	0.30	0.50	0.0118	0.0196
L2	0.2	5 BSC	0.010 BSC	
a°	4°	12°	4°	12°

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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